



	LCA120	Units
Blocking Voltage	250	V
Load Current	170	mA
Max On Resistance	20	Ω

Features

- Small 6 Pin Surface Mount and DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available
- Flammability classification rating of V-0

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The LCA120 is a 1-Form-A solid state relay which uses optically coupled MOSFET technology to provide 3750V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture. The optically-coupled input is controlled by a highly efficient GaAIAs infrared LED. The LCA120 can be used to replace mechanical relays and offers the superior reliability associated with semiconductor devices. Because they have no moving parts, they can offer faster, bounce-free switching in a more compact surface mount or through hole package.

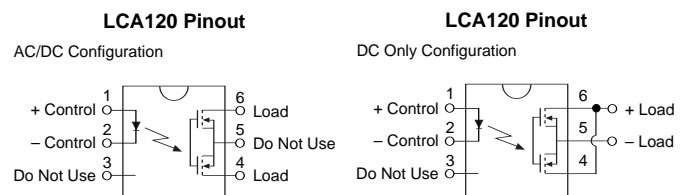
Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- Certified to: EN 60950, EN 41003, AS/NZS 3260, IEC 950

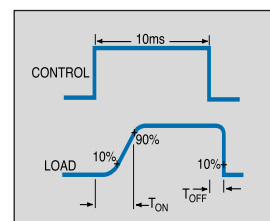
Ordering Information

Part #	Description
LCA120	6 Pin DIP (50/Tube)
LCA120S	6 Pin Surface Mount (50/Tube)
LCA120STR	6 Pin Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Ratings	Units
Blocking Voltage	250	V _p
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	150 ¹	mW
Total Power Dissipation	800 ²	mW
Isolation Voltage Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C
Soldering Temperature DIP Package	+260	°C
Surface Mount Package (10 Seconds Max.)	+220	°C

¹ Derate Linearly 1.33 mW/°C

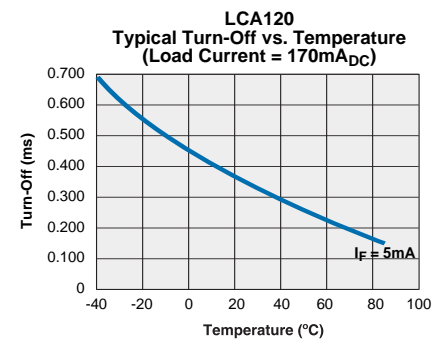
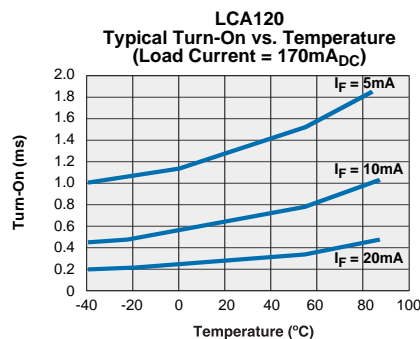
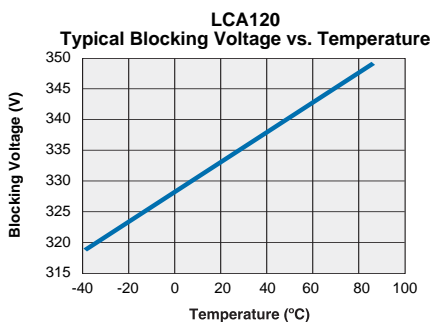
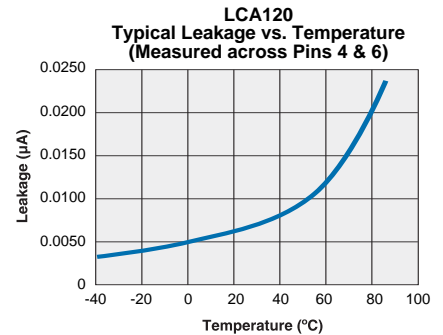
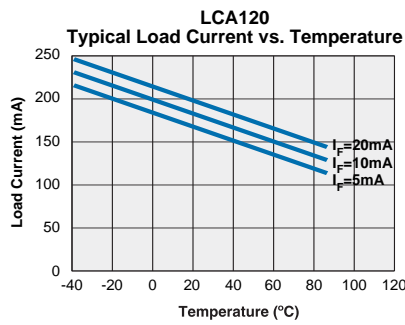
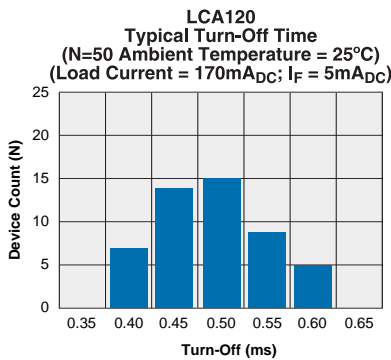
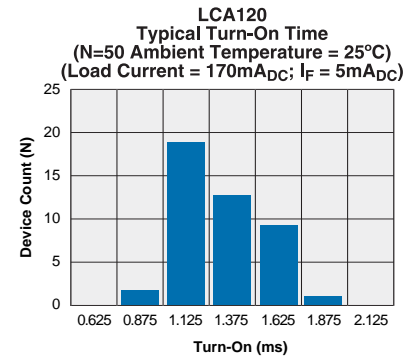
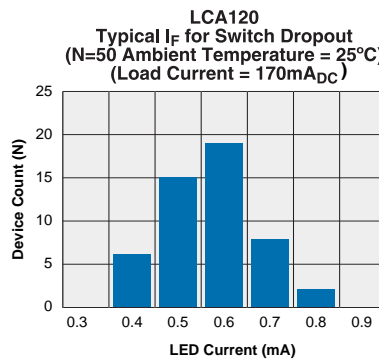
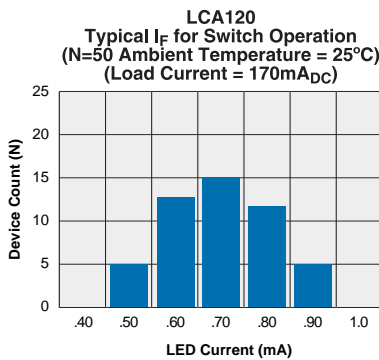
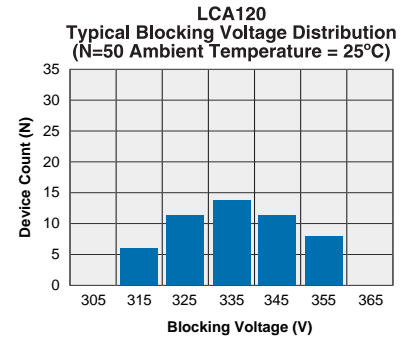
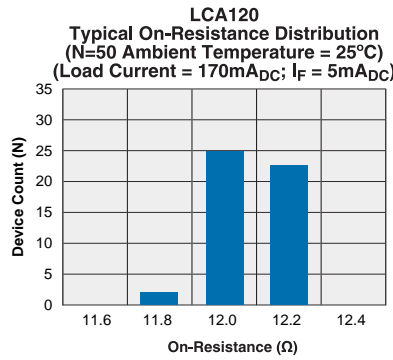
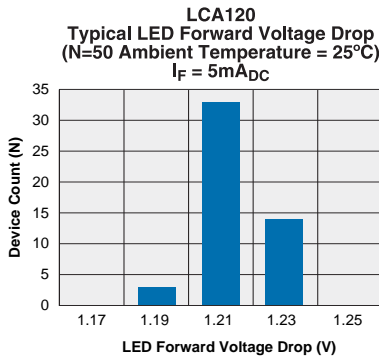
² Derate Linearly 6.67 mW/°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics

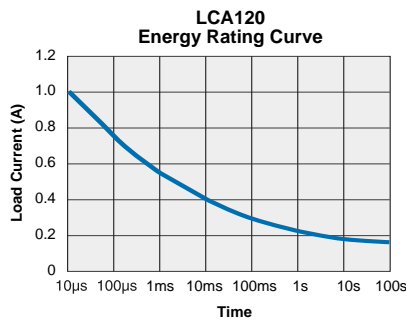
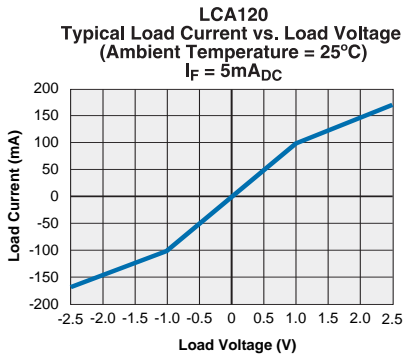
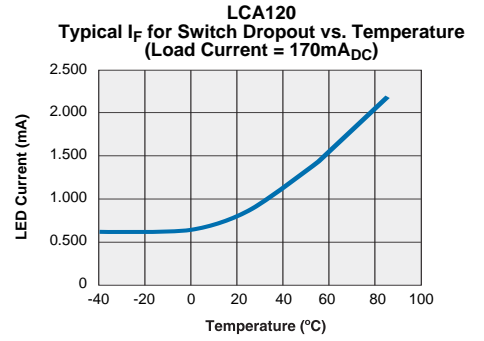
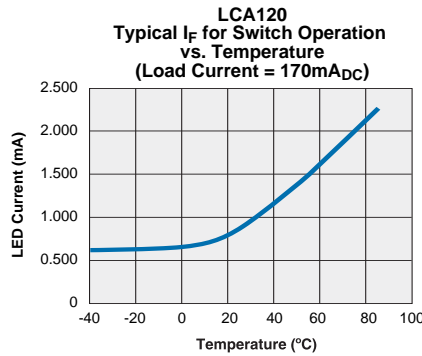
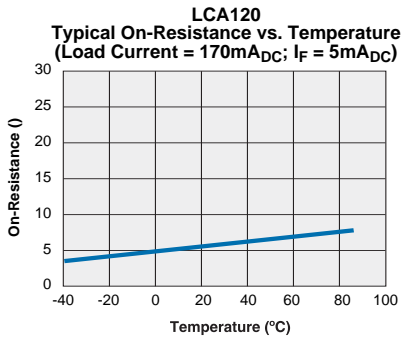
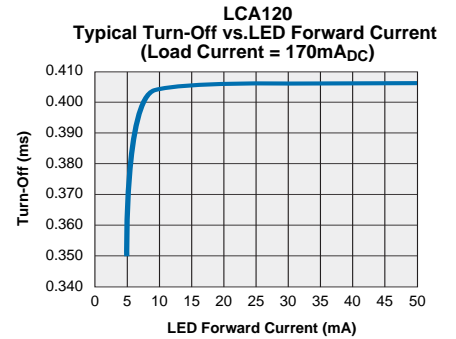
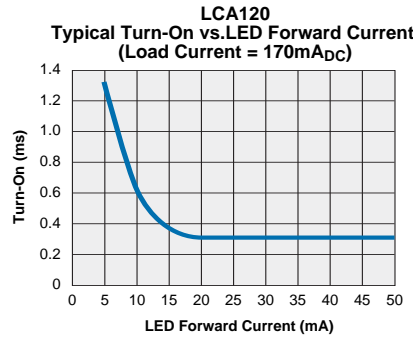
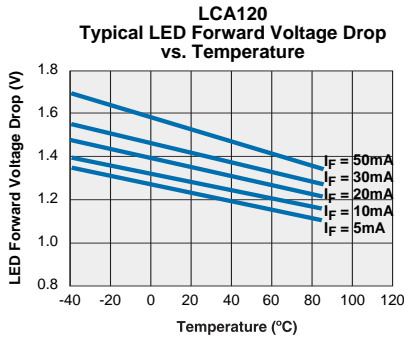
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Current (Continuous) AC/DC Configuration	-	I _L	-	-	170	mA
DC Configuration	-	I _L	-	-	200	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance AC/DC Configuration	I _L =170 mA	R _{ON}	-	15	20	Ω
DC Configuration	I _L =200 mA	-	-	5	6	Ω
Off-State Leakage Current	V _L =250V	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	3	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	3	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	50	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _L =Load Current	I _F	5	-	-	mA
Input Dropout Current	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

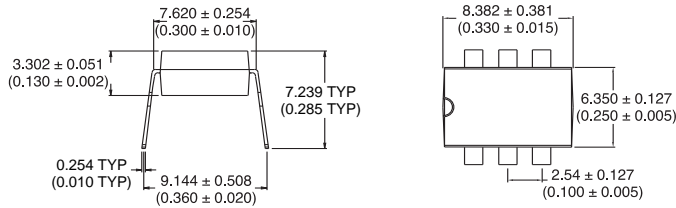
PERFORMANCE DATA*



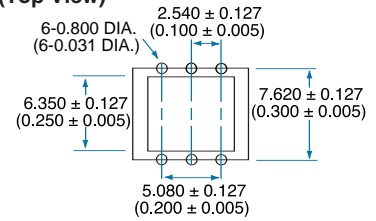
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MECHANICAL DIMENSIONS

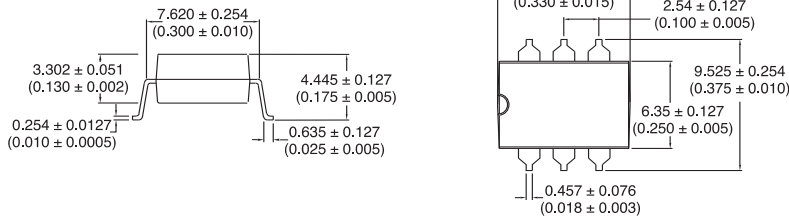
6Pin DIP Through Hole (Standard)



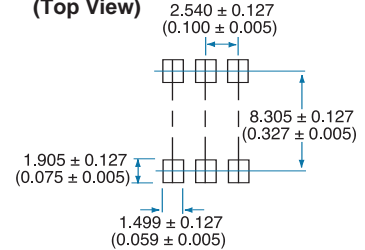
PC Board Pattern (Top View)



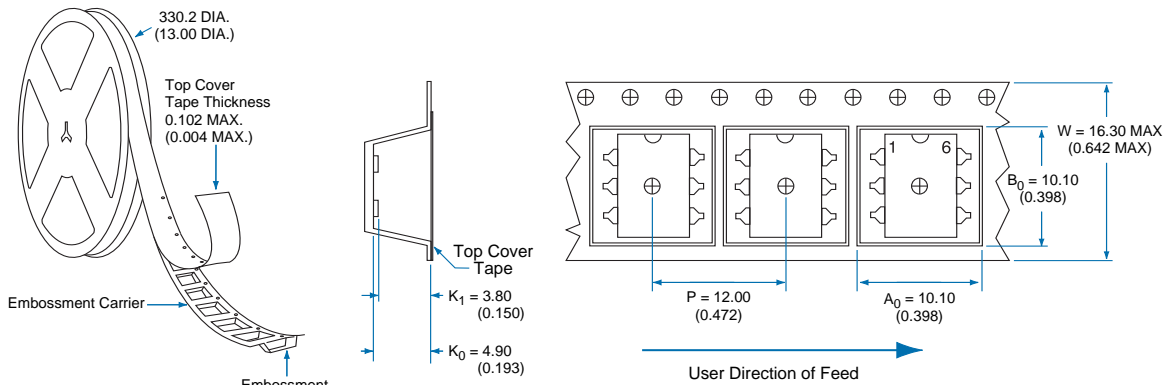
6Pin Surface Mount ("S" Suffix)



PC Board Pattern (Top View)



Tape and Reel Packaging for 6 Pin Surface Mount Package



Dimensions:
mm
(inches)

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